

8M-Bit (1Mx8 /512Kx16) CMOS MASK ROM

FEATURES

- Switchable organization
1,048,576 x 8(byte mode)
524,288 x 16(word mode)
- Random access time/Page Access Time
3.3V Operation : 100/30ns(Max.)
3.0V Operation : 120/40ns(Max.)
- 4 Words / 8 bytes page access
- Supply voltage : single +3.0V/ single +3.3V
- Current consumption
Operating : 40mA(Max.)
Standby : 30μA(Max.)
- Fully static operation
- All inputs and outputs TTL compatible
- Three state outputs
- Package
-. KM23V8105D : 42-DIP-600
-. KM23V8105DG : 44-SOP-600

GENERAL DESCRIPTION

The KM23V8105D(G) is a fully static mask programmable ROM fabricated using silicon gate CMOS process technology, and is organized either as 1,048,576 x 8 bit(byte mode) or as 524,288 x 16 bit(word mode) depending on BHE voltage level.(See mode selection table)

This device includes page read mode function, page read mode allows 4 words (or 8bytes) of data to read fast in the same page, CE and A2 ~ A18 should not be changed.

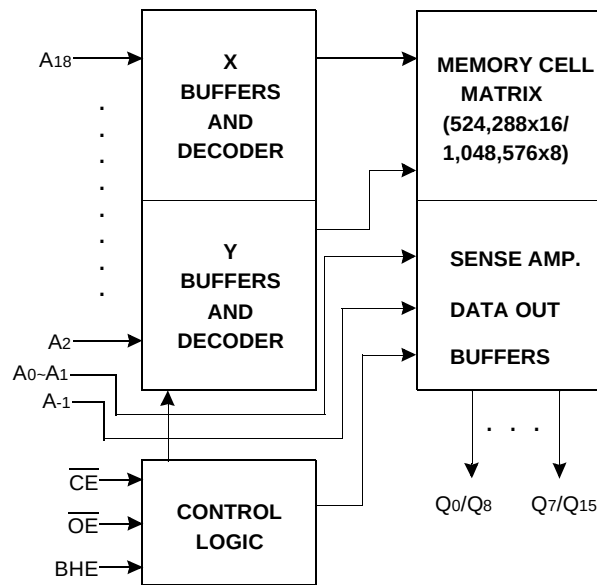
This device operates with a 3.0V or 3.3V power supply, and all inputs and outputs are TTL compatible.

Because of its asynchronous operation, it requires no external clock assuring extremely easy operation.

It is suitable for use in program memory of microprocessor, and data memory, character generator.

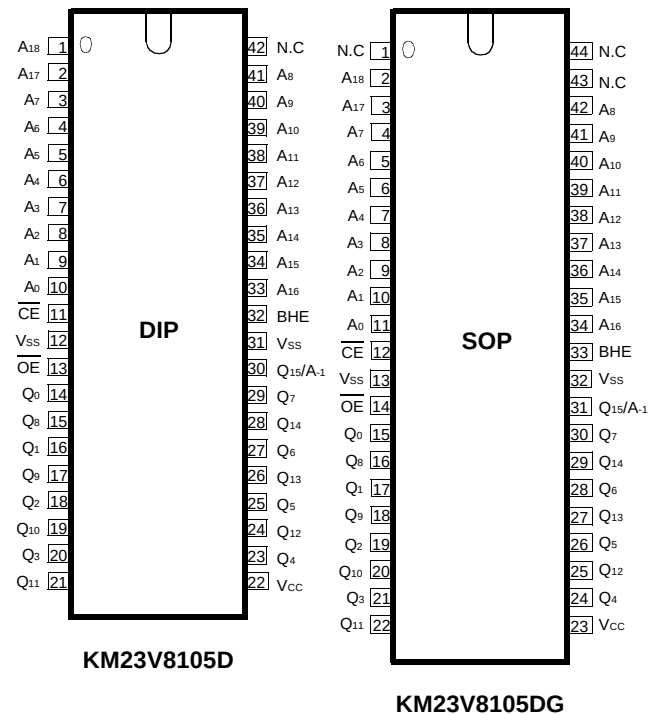
The KM23V8105D is packaged in a 42-DIP and the KM23V8105DG in a 44-SOP.

FUNCTIONAL BLOCK DIAGRAM



Pin Name	Pin Function
A0 - A1	Page Address Inputs
A2 - A18	Address Inputs
Q0 - Q14	Data Outputs
Q15 /A-1	Output 15(Word mode)/ LSB Address(Byte mode)
BHE	Word/Byte selection
CE	Chip Enable
OE	Output Enable
Vcc	Power
Vss	Ground
N.C	No Connection

PIN CONFIGURATION



ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Rating	Unit
Voltage on Any Pin Relative to V _{SS}	V _{IN}	-0.3 to +4.5	V
Temperature Under Bias	T _{BIAS}	-10 to +85	°C
Storage Temperature	T _{STG}	-55 to +150	°C

NOTE : Permanent device damage may occur if "ABSOLUTE MAXIMUM RATINGS" are exceeded. Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS(Voltage reference to V_{SS}, T_A=0 to 70°C)

Item	Symbol	Min	Typ	Max	Unit
Supply Voltage	V _{CC}	2.7/3.0	3.0/3.3	3.3/3.6	V
Supply Voltage	V _{SS}	0	0	0	V

DC CHARACTERISTICS

Parameter	Symbol	Test Conditions		Min	Max	Unit
Operating Current	I _{CC}	$\overline{CE}=\overline{OE}=V_{IL}$, all outputs open	V _{CC} =3.3V±0.3V	-	40	mA
			V _{CC} =3.0V±0.3V		35	mA
Standby Current(TTL)	I _{SB1}	$\overline{CE}=V_{IH}$, all outputs open			500	μA
Standby Current(CMOS)	I _{SB2}	$\overline{CE}=V_{CC}$, all outputs open			30	μA
Input Leakage Current	I _{LI}	V _{IN} =0 to V _{CC}		-	10	μA
Output Leakage Current	I _{LO}	V _{OUT} =0 to V _{CC}		-	10	μA
Input High Voltage, All Inputs	V _{IH}			2.0	V _{CC} +0.3	V
Input Low Voltage, All Inputs	V _{IL}			-0.3	0.6	V
Output High Voltage Level	V _{OH}	I _{OH} =-400μA		2.4	-	V
Output Low Voltage Level	V _{OL}	I _{OL} =2.1mA		-	0.4	V

NOTE : Minimum DC Voltage(V_{IL}) is -0.3V an input pins. During transitions, this level may undershoot to -2.0V for periods <20ns.
Maximum DC voltage on input pins(V_{IH}) is V_{CC}+0.3V which, during transitions, may overshoot to V_{CC}+2.0V for periods <20ns.

MODE SELECTION

CE	OE	BHE	Q _{15/A-1}	Mode	Data	Power
H	X	X	X	Standby	High-Z	Standby
L	H	X	X	Operating	High-Z	Active
L	L	H	Output	Operating	Q ₀ ~Q ₁₅ : Dout	Active
		L	Input	Operating	Q ₀ ~Q ₇ : Dout Q ₈ ~Q ₁₄ : Hi-Z	Active

CAPACITANCE(T_A=25°C, f=1.0MHz)

Item	Symbol	Test Conditions	Min	Max	Unit
Output Capacitance	C _{OUT}	V _{OUT} =0V	-	12	pF
Input Capacitance	C _{IN}	V _{IN} =0V	-	12	pF

NOTE : Capacitance is periodically sampled and not 100% tested.

AC CHARACTERISTICS($T_A=0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$, $V_{CC}=3.3\text{V}/3.0\text{V}\pm 0.3\text{V}$, unless otherwise noted.)**TEST CONDITIONS**

Item	Value
Input Pulse Levels	0.45V to 2.4V
Input Rise and Fall Times	10ns
Input and Output timing Levels	1.5V
Output Loads	1 TTL Gate and $C_L=100\text{pF}$

READ CYCLE

Item	Symbol	$V_{CC}=3.3\text{V}\pm 0.3\text{V}$		$V_{CC}=3.0\text{V}\pm 0.3\text{V}$		Unit
		Min	Max	Min	Max	
Read Cycle Time	t _{RC}	100		120		ns
Chip Enable Access Time	t _{ACE}		100		120	ns
Address Access Time	t _{AA}		100		120	ns
Page Address Access Time	t _{PA}		30		40	ns
Output Enable Access Time	t _{OE}		30		40	ns
Output or Chip Disable to Output High-Z	t _{DF}		20		20	ns
Output Hold from Address Change	t _{OH}	0		0		ns

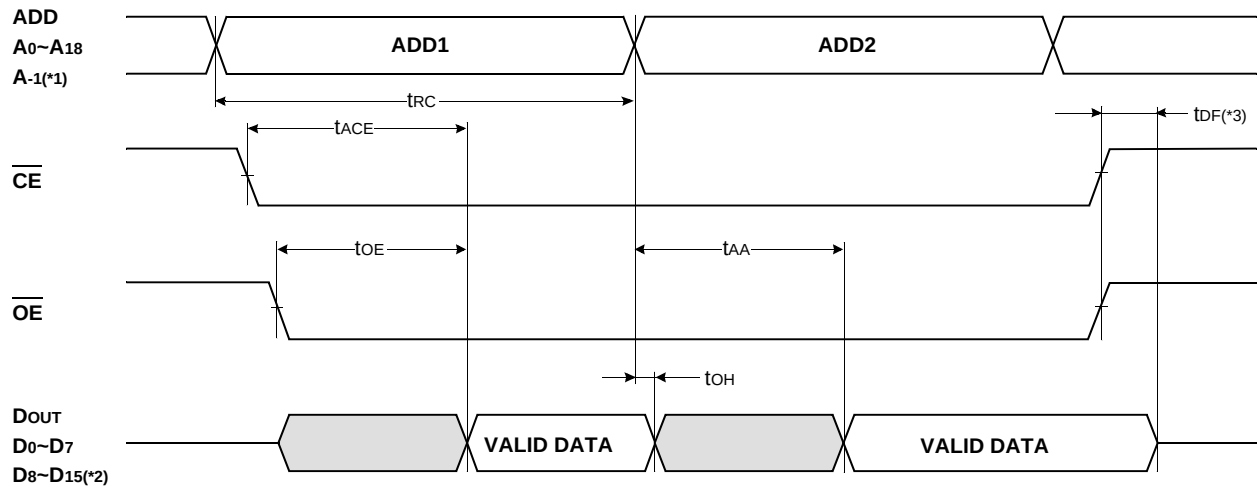
NOTE : Page Address is determined as below.

Word mode (BHE = V_{IH}) : A₀, A₁

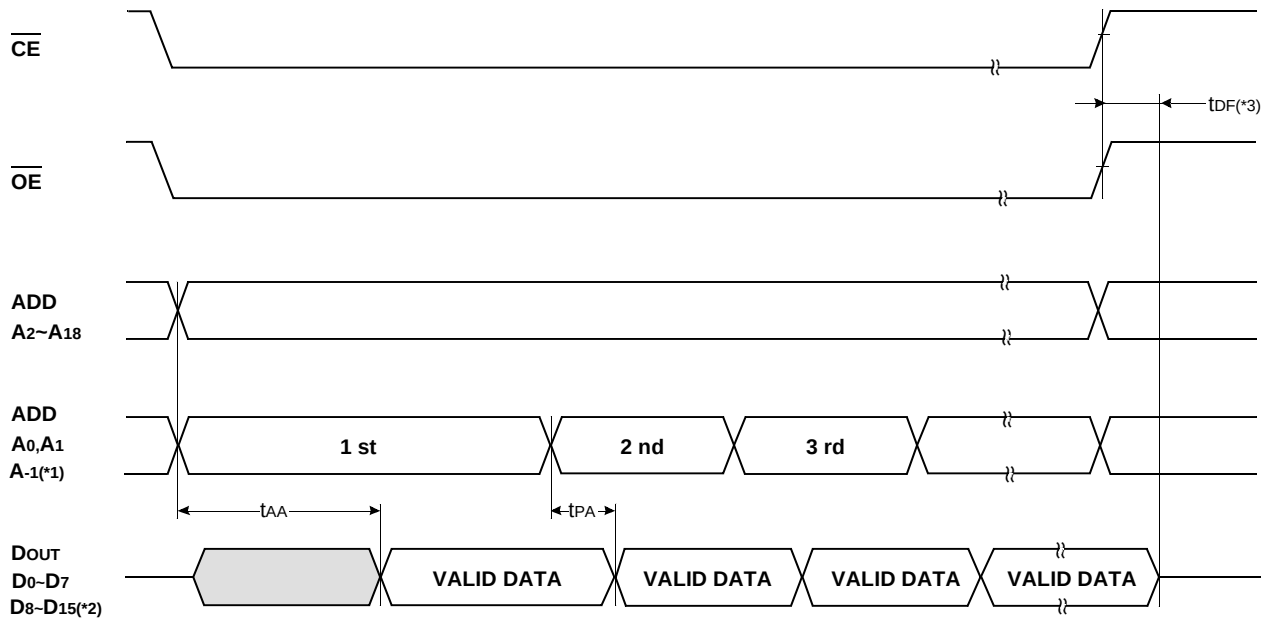
Byte mode (BHE = V_{IL}) : A₋₁, A₀, A₁

TIMING DIAGRAM

READ



PAGE READ



NOTES :

*1. Byte Mode only. A-1 is Least Significant Bit Address.(BHE = V_{IL})

*2. Word Mode only.(BHE = V_{IH})

*3. t_{DF} is defined as the time at which the outputs achieve the open circuit condition and is not referenced to V_{OH} or V_{OL} level.

PACKAGE DIMENSIONS

(Unit : mm/inch)

